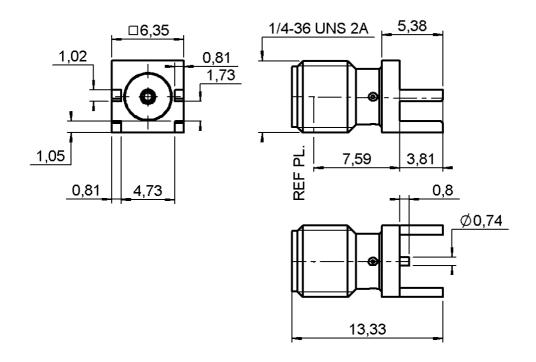
# STRAIGHT JACK RECEPTACLE FOR PCB SMT TYPE - EDGE CARD.

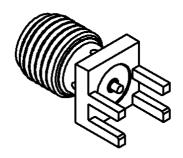
R124.423.223

Series: SMA-COM





Scale: 1/1



All dimensions are in mm.



	COMPONENTS	MATERIALS	PLATING (µm)
_	BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	BRASS BERYLLIUM COPPER - PTFE	GOLD 0.5 OVER NICKEL 2 GOLD 1.3 OVER NICKEL2

**Issue:** 1149 A

In the effort to improve our products, we reserve the right to make changes judged to be



# STRAIGHT JACK RECEPTACLE FOR PCB

**SMT TYPE - EDGE CARD.** 

R124.423.223

Series: **SMA-COM** 

### **PACKAGING**

Standard	Unit	Other
100	'W' option	Contact us

### **SPECIFICATION**

# **ELECTRICAL CHARACTERISTICS**

Impedance  $50 \Omega$  Frequency 0-18 GHz

Frequency **0-18** GHz VSWR **1.14** + **0,0000** x F(GHz) Maxi

Insertion loss  $0.05 \sqrt{F(GHz)} dB Maxi$ 

RF leakage - ( 100 - F(GHz)) dB Maxi

Voltage rating 500 Veff Maxi Dielectric withstanding voltage Insulation resistance 500 M $\Omega$  mini

### **ENVIRONMENTAL**

Operating temperature -65/+165 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

## **OTHER CHARACTERISTICS**

Assembly instruction NA

Others:

# **MECHANICAL CHARACTERISTICS**

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

27 N mini
27 N mini
28 N.cm mini

Recommended torque

Mating NA- N.cm Panel nut NA N.cm

Mating life 100 Cycles mini

Weight **1,5620** g

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# **SOLDER PROCEDURE**

1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.

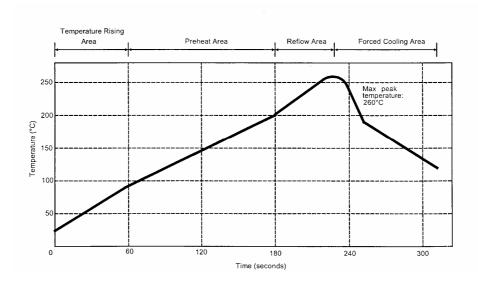
We advise a thickness of 150 microns (5.850 microinch). Verify that the edges of the zone are clean.

2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.

Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.

- 3. Soldering by infra-red reflow. Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

#### TEMPERATURE PROFIL



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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# STRAIGHT JACK RECEPTACLE FOR PCB

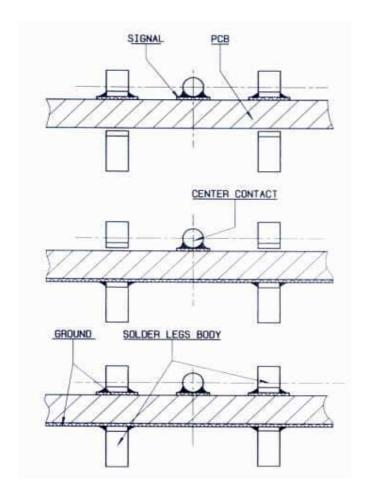
**SMT TYPE - EDGE CARD.** 

R124.423.223

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### **MOUNTING TYPE**

This type of connector is adapted to one specific PCB thickness . It can be used with different ways of transmission .



1- COPLANAR LINE Signal and ground are coplanar .

2 – MICROSTRIP LINE Signal and ground are opposite .

3 – Coplanar and opposite grounds .

Solution 3 features a stronger mechanical retention on the PCB because the 4 leads are soldered

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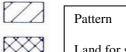
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**SMT TYPE - EDGE CARD.** 

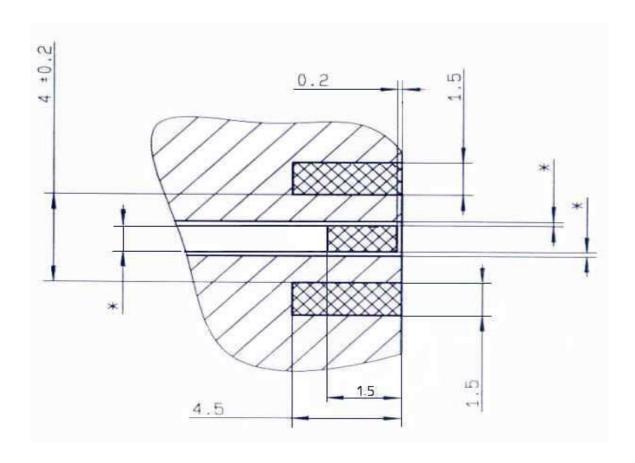
R124.423.223

Series: SMA-COM

### **DIMENSIONS**



Land for solder past



 $^{st}$  Parameters flaged by a star must be defined dimensionally regarding the thickness of the PCB and the transmission way these parameters could be measured by RADIALL if requested .

### **COPLANAR LINE**

Pattern and signal are on the same side The material of PCB is the epoxy resin of glass fabrics bacs . (ER = 4.8)The solder resist should be printed except for the land pattern on the PCB

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